



**HIGH-SPEED 3.3V
8/4K x 18 DUAL-PORT
8/4K x 16 DUAL-PORT
STATIC RAM**

**IDT70V35/34S/L
IDT70V25/24S/L**

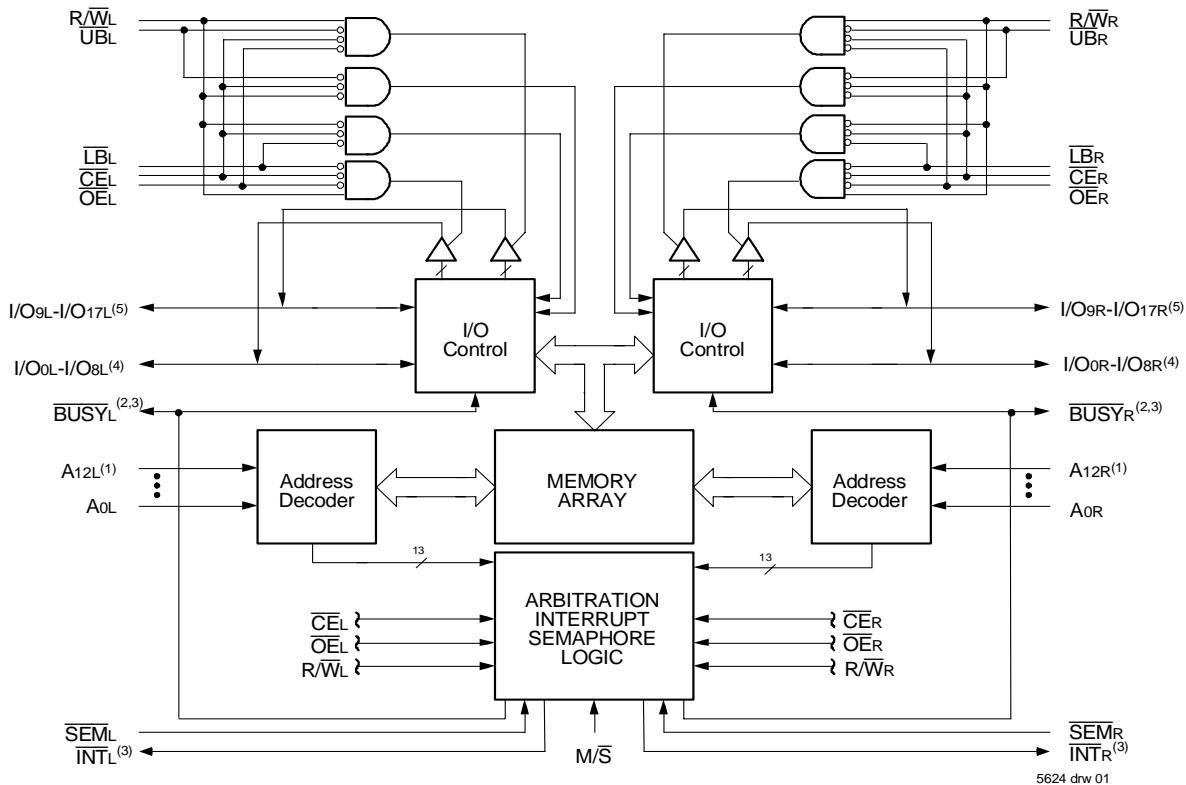
Features

- ◆ True Dual-Ported memory cells which allow simultaneous reads of the same memory location
- ◆ High-speed access
IDT70V35/34
 - Commercial: 15/20/25ns (max.)
 - Industrial: 20ns**IDT70V25/24**
 - Commercial: 15/20/25/35/55ns (max.)
 - Industrial: 20/25ns
- ◆ Low-power operation

| | |
|--|--|
| <ul style="list-style-type: none"> - IDT70V35/34S Active: 430mW (typ.) Standby: 3.3mW (typ.) - IDT70V25/24S Active: 400mW (typ.) Standby: 3.3mW (typ.) | <ul style="list-style-type: none"> - IDT70V35/34L Active: 415mW (typ.) Standby: 660µW (typ.) - IDT70V25/24L Active: 380mW (typ.) Standby: 660µW (typ.) |
|--|--|

- ◆ Separate upper-byte and lower-byte control for multiplexed bus compatibility
- ◆ IDT70V35/34 (IDT70V25/24) easily expands data bus width to 36 bits (32 bits) or more using the Master/Slave select when cascading more than one device
- ◆ $M/\bar{S} = V_{IH}$ for \overline{BUSY} output flag on Master
 $M/\bar{S} = V_{IL}$ for \overline{BUSY} input on Slave
- ◆ \overline{BUSY} and Interrupt Flag
- ◆ On-chip port arbitration logic
- ◆ Full on-chip hardware support of semaphore signaling between ports
- ◆ Fully asynchronous operation from either port
- ◆ LVTTTL-compatible, single 3.3V ($\pm 0.3V$) power supply
- ◆ Available in a 100-pin TQFP (IDT70V35/24) & (IDT70V25/24), 86-pin PGA (IDT70V25/24) and 84-pin PLCC (IDT70V25/24)
- ◆ Industrial temperature range (-40°C to +85°C) is available for selected speeds
- ◆ Green parts available, see ordering information

Functional Block Diagram



NOTES:

1. A12 is a NC for IDT70V34 and for IDT70V24.
2. (MASTER): \overline{BUSY} is output; (SLAVE): \overline{BUSY} is input.
3. \overline{BUSY} outputs and \overline{INT} outputs are non-tri-stated push-pull.
4. I/O0x - I/O7x for IDT70V25/24.
5. I/O8x - I/O15x for IDT70V25/24.

5624 dw 01

OCTOBER 2008

Description

The IDT70V35/34 (IDT70V25/24) is a high-speed 8/4K x 18 (8/4K x 16) Dual-Port Static RAM. The IDT70V35/34 (IDT70V25/24) is designed to be used as a stand-alone Dual-Port RAM or as a combination MASTER/SLAVE Dual-Port RAM for 36-bit (32-bit) or wider memory system applications results in full-speed, error-free operation without the need for additional discrete logic.

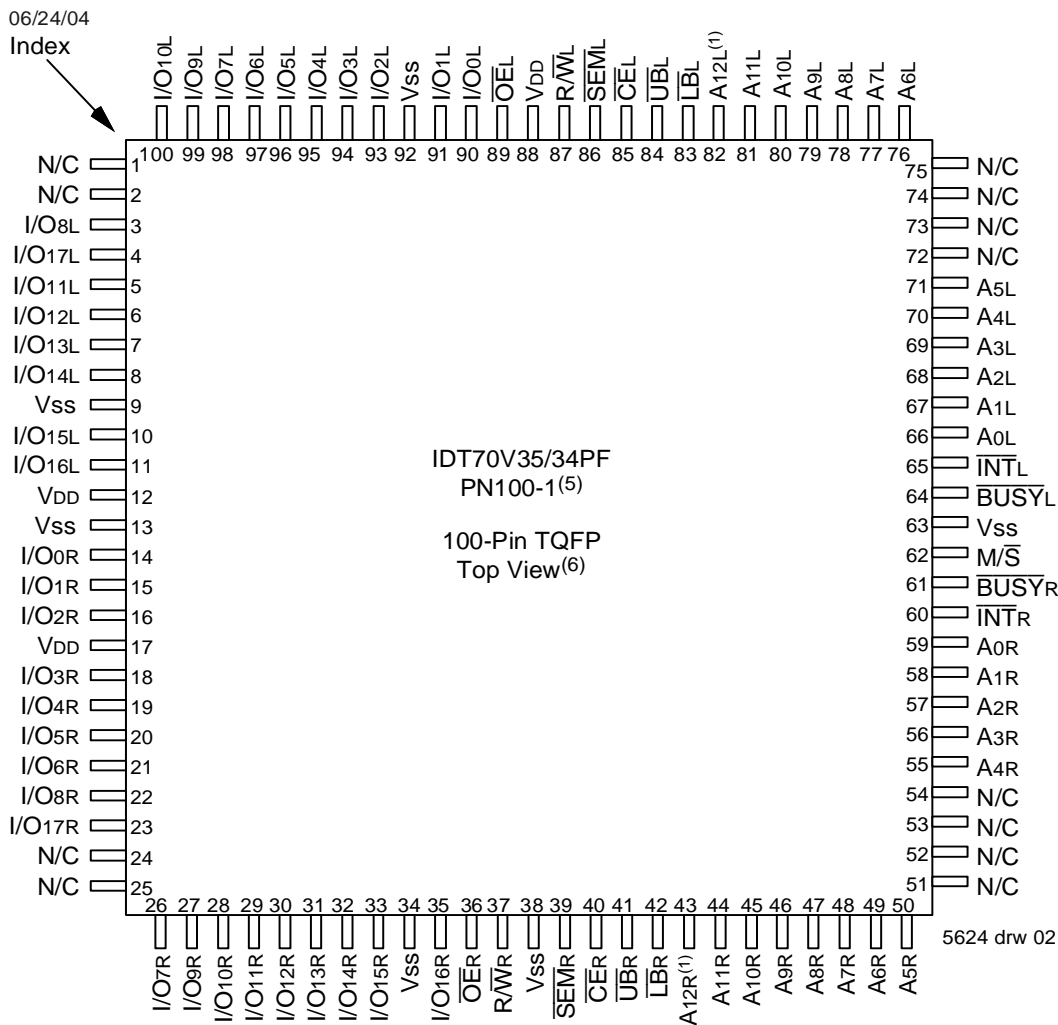
This device provides two independent ports with separate control, address, and I/O pins that permit independent, asynchronous access for reads or writes to any location in memory. An automatic power down

feature controlled by \overline{CE} permits the on-chip circuitry of each port to enter a very low standby power mode.

Fabricated using IDT's CMOS high-performance technology, these devices typically operate on only 430mW (IDT70V35/34) and 400mW (IDT70V25/24) of power.

The IDT70V35/34 (IDT70V25/24) is packaged in a plastic 100-pin Thin Quad Flatpack. The IDT70V25/24 is packaged in a ceramic 84-pin PGA and 84-Pin PLCC.

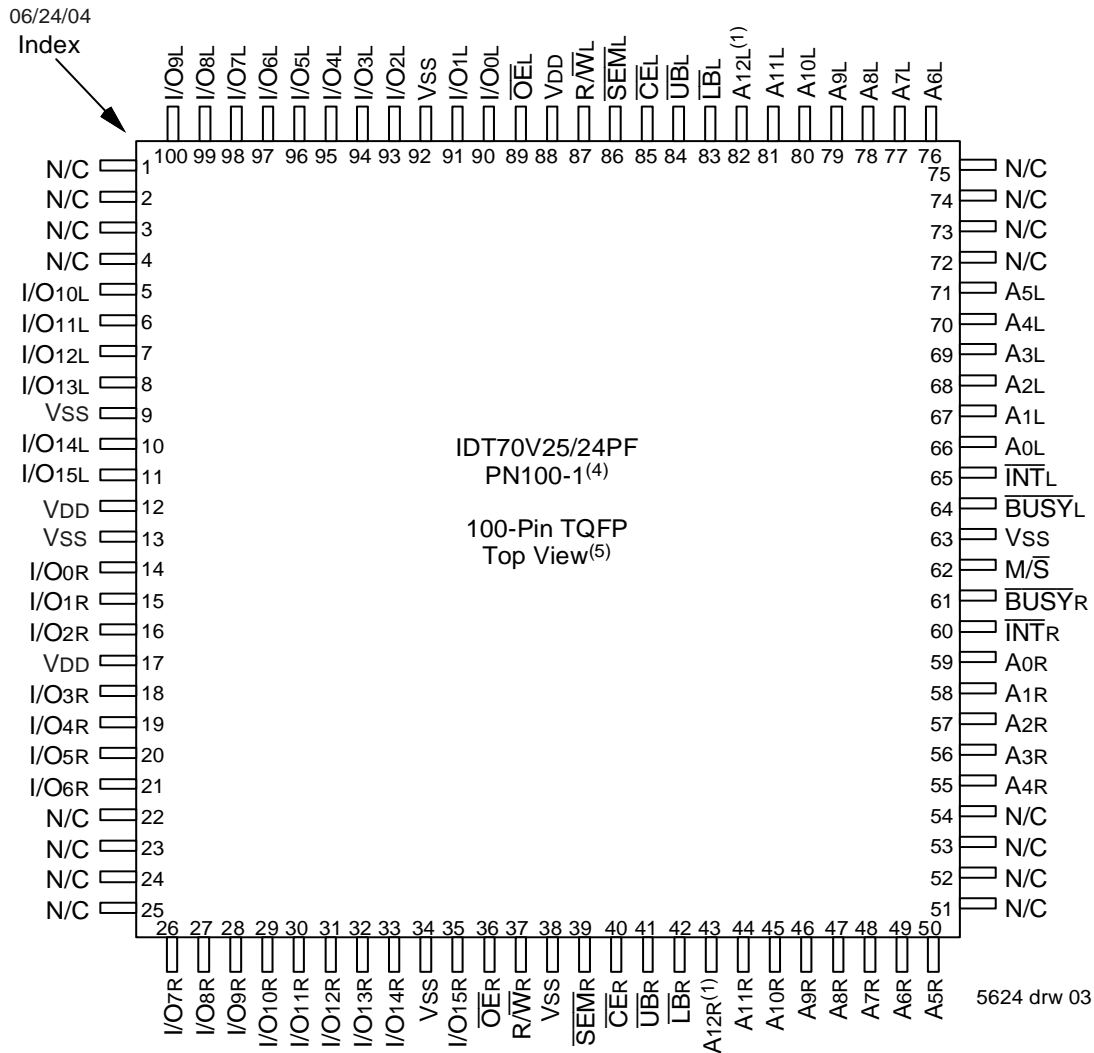
Pin Configurations^(1,2,3,4)



NOTES:

1. A12 is a NC for IDT70V34.
2. All VDD pins must be connected to power supply.
3. All VSS pins must be connected to ground.
4. PN100-1 package body is approximately 14mm x 14mm x 1.4mm.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part marking.

Pin Configurations^(1,2,3,4)(con't)

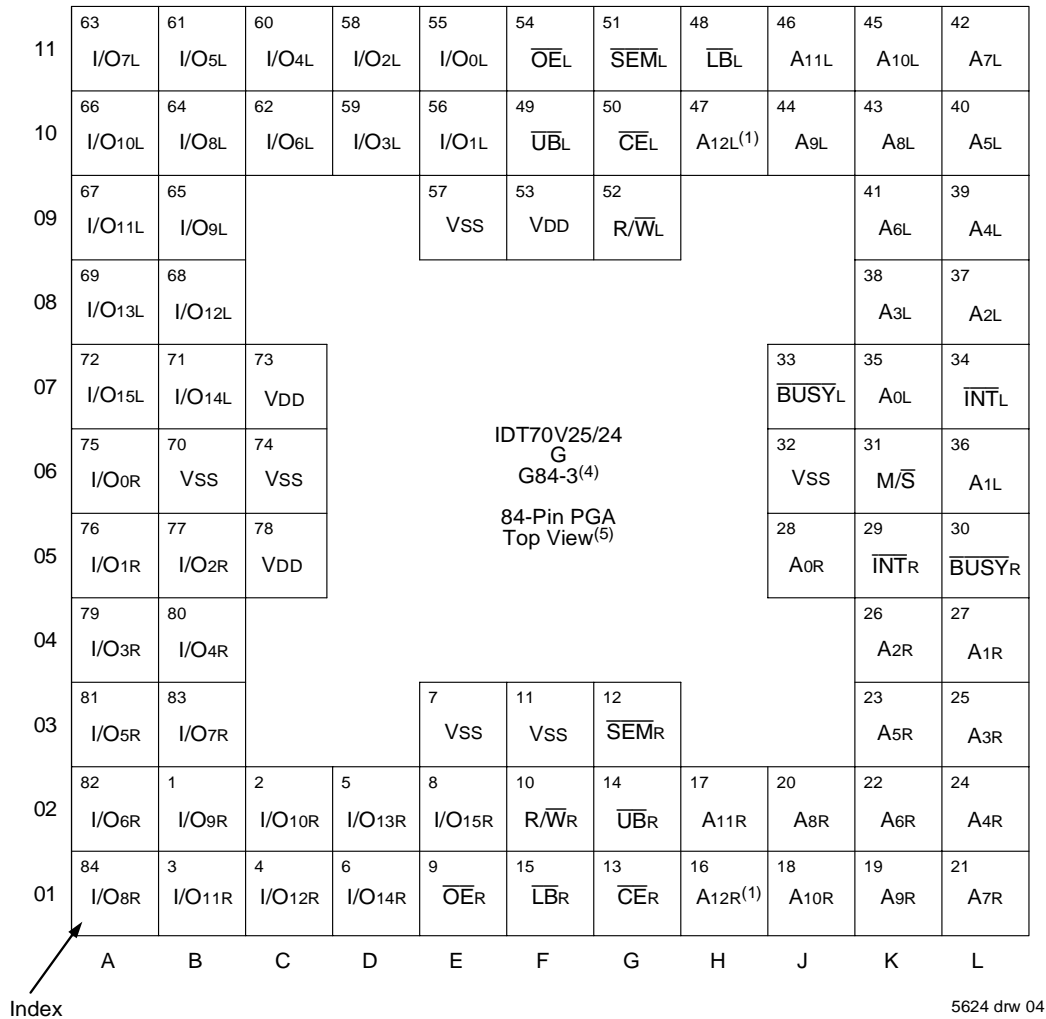


NOTES:

1. A12 is a NC for IDT70V24.
2. All VDD pins must be connected to power supply.
3. All VSS pins must be connected to ground.
4. PN100-1 package body is approximately 14mm x 14mm x 1.4mm.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part marking.

Pin Configurations^(1,2,3,4)(con't)

06/11/04

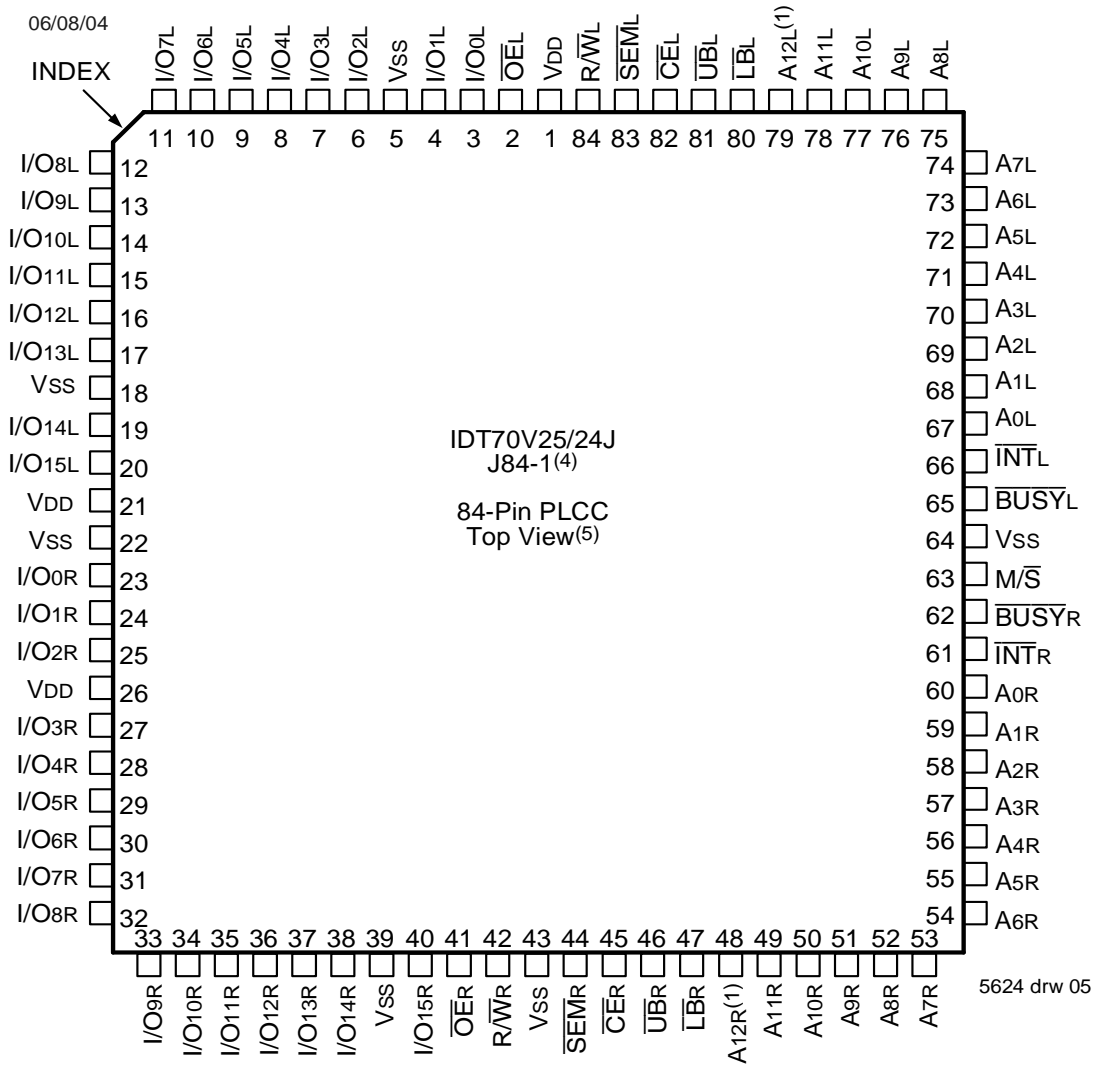


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NOTES:

1. A12 is a NC for IDT70V24.
2. All VDD pins must be connected to power supply.
3. All VSS pins must be connected to ground supply.
4. G84-3 package body is approximately 1.12 in x 1.12 in x .16 in.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part marking.

Pin Configurations^(1,2,3,4)(con't)



NOTES:

1. A12 is a NC for IDT70V24.
2. All V_{DD} pins must be connected to power supply.
3. All V_{SS} pins must be connected to ground.
4. J84-1 package body is approximately 1.15 in x 1.15 in x .17 in.
5. This package code is used to reference the package diagram.
6. This text does not indicate orientation of the actual part marking.

Pin Names

| Left Port | Right Port | Names |
|---|---|----------------------------------|
| \overline{CE}_L | \overline{CE}_R | Chip Enable |
| R/\overline{W}_L | R/\overline{W}_R | Read/Write Enable |
| \overline{OE}_L | \overline{OE}_R | Output Enable |
| A _{0L} - A _{12L} ⁽¹⁾ | A _{0R} - A _{12R} ⁽¹⁾ | Address |
| I/O _{0L} - I/O _{17L} ⁽²⁾ | I/O _{0R} - I/O _{17R} ⁽²⁾ | Data Input/Output |
| \overline{SEM}_L | \overline{SEM}_R | Semaphore Enable |
| \overline{UB}_L | \overline{UB}_R | Upper Byte Select ⁽³⁾ |
| \overline{LB}_L | \overline{LB}_R | Lower Byte Select ⁽⁴⁾ |
| \overline{INT}_L | \overline{INT}_R | Interrupt Flag |
| \overline{BUSY}_L | \overline{BUSY}_R | Busy Flag |
| M/ \overline{S} | | Master or Slave Select |
| V _{DD} | | Power (3.3V) |
| V _{SS} | | Ground (0V) |

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NOTES:

1. A₁₂ is a NC for IDT70V34 and for IDT70V24.
2. I/O_{0x} - I/O_{15x} for IDT70V25/24.
3. Upper Byte Select controls pins 9-17 for IDT70V35/34 and controls pins 8-15 for IDT70V25/24.
4. Lower Byte Select controls pins 0-8 for IDT70V35/34 and controls pins 0-7 for IDT70V25/24.

Truth Table I: Non-Contention Read/Write Control

| Inputs ⁽¹⁾ | | | | | | Outputs | | Mode |
|-----------------------|-------------------|-----------------|-----------------|-----------------|------------------|------------------------------------|-----------------------------------|--------------------------|
| \overline{CE} | R/ \overline{W} | \overline{OE} | \overline{UB} | \overline{LB} | \overline{SEM} | I/O ₉₋₁₇ ⁽³⁾ | I/O ₀₋₈ ⁽²⁾ | |
| H | X | X | X | X | H | High-Z | High-Z | Deselected: Power Down |
| X | X | X | H | H | H | High-Z | High-Z | Both Bytes Deselected |
| L | L | X | L | H | H | DATA _{IN} | High-Z | Write to Upper Byte Only |
| L | L | X | H | L | H | High-Z | DATA _{IN} | Write to Lower Byte Only |
| L | L | X | L | L | H | DATA _{IN} | DATA _{IN} | Write to Both Bytes |
| L | H | L | L | H | H | DATA _{OUT} | High-Z | Read Upper Byte Only |
| L | H | L | H | L | H | High-Z | DATA _{OUT} | Read Lower Byte Only |
| L | H | L | L | L | H | DATA _{OUT} | DATA _{OUT} | Read Both Bytes |
| X | X | H | X | X | X | High-Z | High-Z | Outputs Disabled |

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NOTES:

1. A_{0L}-A_{12L} ≠ A_{0R}-A_{12R} for IDT70V35/34 and A_{0L}-A_{11L} ≠ A_{0R}-A_{11R} for IDT70V25/24.
2. Outputs for IDT70V25/24 are I/O_{0x}-I/O_{7x}.
3. Outputs for IDT70V25/24 are I/O_{8x}-I/O_{15x}.

Truth Table II: Semaphore Read/Write Control⁽¹⁾

| Inputs | | | | | | Outputs | | Mode |
|-----------------|-------------------|-----------------|-----------------|-----------------|------------------|------------------------------------|-----------------------------------|--|
| \overline{CE} | R/ \overline{W} | \overline{OE} | \overline{UB} | \overline{LB} | \overline{SEM} | I/O ₉₋₁₇ ⁽¹⁾ | I/O ₀₋₈ ⁽¹⁾ | |
| H | H | L | X | X | L | DATA _{OUT} | DATA _{OUT} | Read Data in Semaphore Flag |
| X | H | L | H | H | L | DATA _{OUT} | DATA _{OUT} | Read Data in Semaphore Flag |
| H | ↑ | X | X | X | L | DATA _{IN} | DATA _{IN} | Write I/O ₀ into Semaphore Flag |
| X | ↑ | X | H | H | L | DATA _{IN} | DATA _{IN} | Write I/O ₀ into Semaphore Flag |
| L | X | X | L | X | L | — | — | Not Allowed |
| L | X | X | X | L | L | — | — | Not Allowed |

NOTE:

1. There are eight semaphore flags written to via I/O₀ and read from all of the I/O's (I/O₀-I/O₁₇ for IDT70V35/34) and (I/O₀-I/O₁₅ for IDT70V25/24). These eight semaphores are addressed by A₀-A₂.

5624 tbl 03

Absolute Maximum Ratings⁽¹⁾

| Symbol | Rating | Commercial & Industrial | Unit |
|----------------------------------|--------------------------------------|-------------------------|------|
| V _{TERM} ⁽²⁾ | Terminal Voltage with Respect to GND | -0.5 to +4.6 | V |
| T _{BIAS} | Temperature Under Bias | -55 to +125 | °C |
| T _{STG} | Storage Temperature | -65 to +150 | °C |
| T _{JN} | Junction Temperature | +150 | °C |
| I _{OUT} | DC Output Current | 50 | mA |

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NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V_{TERM} must not exceed V_{DD} + 0.3V for more than 25% of the cycle time or 10ns maximum, and is limited to ≤ 20mA for the period of V_{TERM} ≥ V_{DD} + 0.3V.

Capacitance⁽¹⁾ (T_A = +25°C, f = 1.0MHz)

| Symbol | Parameter | Conditions | Max. | Unit |
|---------------------------------|--------------------|-----------------------|------|------|
| C _{IN} | Input Capacitance | V _{IN} = 0V | 9 | pF |
| C _{OUT} ⁽²⁾ | Output Capacitance | V _{OUT} = 0V | 10 | pF |

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NOTES:

- This parameter is determined by device characterization but is not production tested.
- C_{OUT} also references C_{I/O}.

Maximum Operating Temperature and Supply Voltage⁽¹⁾

| Grade | Ambient Temperature | GND | V _{DD} |
|------------|---------------------|-----|-----------------|
| Commercial | 0°C to +70°C | 0V | 3.3V ± 0.3V |
| Industrial | -40°C to +85°C | 0V | 3.3V ± 0.3V |

5624 tbl 05

NOTE:

- This is the parameter T_A. This is the "instant on" case temperature.

Recommended DC Operating Conditions

| Symbol | Parameter | Min. | Typ. | Max. | Unit |
|-----------------|--------------------|---------------------|------|-------------------------------------|------|
| V _{DD} | Supply Voltage | 3.0 | 3.3 | 3.6 | V |
| V _{SS} | Ground | 0 | 0 | 0 | V |
| V _{IH} | Input High Voltage | 2.0 | — | V _{DD} +0.3 ⁽²⁾ | V |
| V _{IL} | Input Low Voltage | -0.3 ⁽¹⁾ | — | 0.8 | V |

5624 tbl 06

NOTES:

- V_{IL} ≥ -1.5V for pulse width less than 10ns.
- V_{TERM} must not exceed V_{DD} + 0.3V.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range (V_{DD} = 3.3V ± 0.3V)

| Symbol | Parameter | Test Conditions | 70V35/34/25/24S | | 70V35/34/25/24L | | Unit |
|-----------------|---------------------------------------|---|-----------------|------|-----------------|------|------|
| | | | Min. | Max. | Min. | Max. | |
| I _L | Input Leakage Current ⁽¹⁾ | V _{DD} = 3.6V, V _{IN} = 0V to V _{DD} | — | 10 | — | 5 | μA |
| I _{LO} | Output Leakage Current ⁽¹⁾ | $\overline{CE} = V_{IH}$, V _{OUT} = 0V to V _{DD} | — | 10 | — | 5 | μA |
| V _{OL} | Output Low Voltage | I _{OL} = +4mA | — | 0.4 | — | 0.4 | V |
| V _{OH} | Output High Voltage | I _{OH} = -4mA | 2.4 | — | 2.4 | — | V |

5624 tbl 08

NOTE:

- At V_{DD} ≤ 2.0V leakages are undefined.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V35/34⁽¹⁾ (V_{DD} = 3.3V ± 0.3V)

| Symbol | Parameter | Test Condition | Version | 70V35/34X15 Com'l Only | | 70V35/34X20 Com'l & Ind | | 70V35/34X25 Com'l Only | | Unit | |
|------------------|---|--|-----------|------------------------|------|-------------------------|------|------------------------|------|------|----|
| | | | | Typ. ⁽²⁾ | Max. | Typ. ⁽²⁾ | Max. | Typ. ⁽²⁾ | Max. | | |
| I _{DD} | Dynamic Operating Current (Both Ports Active) | $\overline{CE} = V_{IL}$, Outputs Disabled $SEM = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 150 | 215 | 140 | 200 | 130 | 190 | mA |
| | | | | L | 140 | 185 | 130 | 175 | 125 | 165 | |
| | | | IND | S | — | — | 140 | 225 | — | — | |
| | | | | L | — | — | 130 | 195 | — | — | |
| I _{SB1} | Standby Current (Both Ports - TTL Level Inputs) | \overline{CE}_R and $\overline{CE}_L = V_{IH}$ $SEM_R = SEM_L = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 25 | 35 | 20 | 30 | 16 | 30 | mA |
| | | | | L | 20 | 30 | 15 | 25 | 13 | 25 | |
| | | | MIL & IND | S | — | — | 20 | 45 | — | — | |
| | | | | L | — | — | 15 | 40 | — | — | |
| I _{SB2} | Standby Current (One Port - TTL Level Inputs) | $\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(5)}$ Active Port Outputs Disabled, $f = f_{MAX}^{(3)}$ $SEM_R = SEM_L = V_{IH}$ | COM'L | S | 85 | 120 | 80 | 110 | 75 | 110 | mA |
| | | | | L | 80 | 110 | 75 | 100 | 72 | 95 | |
| | | | MIL & IND | S | — | — | 80 | 130 | — | — | |
| | | | | L | — | — | 75 | 115 | — | — | |
| I _{SB3} | Full Standby Current (Both Ports - CMOS Level Inputs) | Both Ports \overline{CE}_L and $\overline{CE}_R \geq V_{DD} - 0.2V$, $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(4)}$ $SEM_R = SEM_L \geq V_{DD} - 0.2V$ | COM'L | S | 1.0 | 5 | 1.0 | 5 | 1.0 | 5 | mA |
| | | | | L | 0.2 | 2.5 | 0.2 | 2.5 | 0.2 | 2.5 | |
| | | | MIL & IND | S | — | — | 1.0 | 15 | — | — | |
| | | | | L | — | — | 0.2 | 5 | — | — | |
| I _{SB4} | Full Standby Current (One Port - CMOS Level Inputs) | $\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{DD} - 0.2V^{(5)}$ $SEM_R = SEM_L \geq V_{DD} - 0.2V$ $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$ Active Port Outputs Disabled, $f = f_{MAX}^{(3)}$ | COM'L | S | 85 | 125 | 80 | 115 | 75 | 105 | mA |
| | | | | L | 80 | 105 | 75 | 100 | 70 | 90 | |
| | | | MIL & IND | S | — | — | 80 | 130 | — | — | |
| | | | | L | — | — | 75 | 115 | — | — | |

5624 tbl 09

NOTES:

- 'X' in part number indicates power rating (S or L)
- V_{DD} = 3.3V, T_A = +25°C, and are not production tested. I_{DD DC} = 115mA (typ.)
- At f = f_{MAX}, address and control lines (except Output Enable) are cycling at the maximum frequency read cycle of 1/t_{RC}, and using "AC Test Conditions" of input levels of GND to 3V.
- f = 0 means no address or control lines change.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".

AC Test Conditions

| | |
|-------------------------------|-----------------|
| Input Pulse Levels | GND to 3.0V |
| Input Rise/Fall Times | 3ns Max. |
| Input Timing Reference Levels | 1.5V |
| Output Reference Levels | 1.5V |
| Output Load | Figures 1 and 2 |

5624 tbl 10

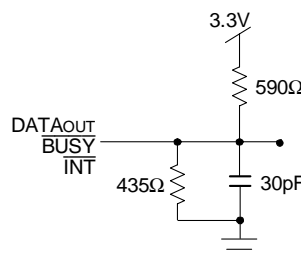
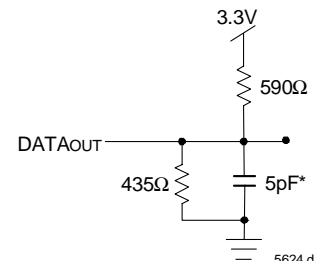


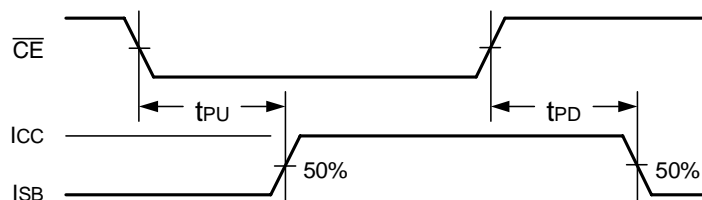
Figure 1. AC Output Test Load



5624 drw 06

Figure 2. Output Test Load
(For t_{LZ}, t_{HZ}, t_{wz}, t_{ow})
*Including scope and jig.

Timing of Power-Up Power-Down



5624 drw 07

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V25/24⁽¹⁾ (V_{DD} = 3.3V ± 0.3V)

| Symbol | Parameter | Test Condition | Version | 70V25/24X15 Com'1 Only | | 70V25/24X20 Com'1 & Ind | | 70V25/24X25 Com'1 & Ind | | Unit | |
|------------------|---|--|-----------|------------------------|------|-------------------------|------|-------------------------|------|------|----|
| | | | | Typ. ⁽²⁾ | Max. | Typ. ⁽²⁾ | Max. | Typ. ⁽²⁾ | Max. | | |
| I _{DD} | Dynamic Operating Current (Both Ports Active) | $\overline{CE} = V_{IL}$, Outputs Open $SEM = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 150 | 215 | 140 | 200 | 130 | 190 | mA |
| | | | | L | 140 | 185 | 130 | 175 | 125 | 165 | |
| | | | IND | S | — | — | 140 | 225 | — | — | |
| | | | | L | — | — | 130 | 195 | 125 | 180 | |
| I _{SB1} | Standby Current (Both Ports - TTL Level Inputs) | \overline{CE}_R and $\overline{CE}_L = V_{IH}$ $SEMR = SEM_L = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 25 | 35 | 20 | 30 | 16 | 30 | mA |
| | | | | L | 20 | 30 | 15 | 25 | 13 | 25 | |
| | | | MIL & IND | S | — | — | 20 | 45 | — | — | |
| | | | | L | — | — | 15 | 40 | 13 | 40 | |
| I _{SB2} | Standby Current (One Port - TTL Level Inputs) | $\overline{CE}^{*A} = V_{IL}$ and $\overline{CE}^{*B} = V_{IH}^{(5)}$ Active Port Outputs Open, $f = f_{MAX}^{(3)}$ $SEMR = SEM_L = V_{IH}$ | COM'L | S | 85 | 120 | 80 | 110 | 75 | 110 | mA |
| | | | | L | 80 | 110 | 75 | 100 | 72 | 95 | |
| | | | MIL & IND | S | — | — | 80 | 130 | — | — | |
| | | | | L | — | — | 75 | 115 | 72 | 110 | |
| I _{SB3} | Full Standby Current (Both Ports - CMOS Level Inputs) | Both Ports \overline{CE}_L and $\overline{CE}_R \geq V_{DD} - 0.2V$, $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(4)}$ $SEMR = SEM_L \geq V_{DD} - 0.2V$ | COM'L | S | 1.0 | 5 | 1.0 | 5 | 1.0 | 5 | mA |
| | | | | L | 0.2 | 2.5 | 0.2 | 2.5 | 0.2 | 2.5 | |
| | | | MIL & IND | S | — | — | 1.0 | 15 | — | — | |
| | | | | L | — | — | 0.2 | 5 | 0.2 | 5 | |
| I _{SB4} | Full Standby Current (One Port - CMOS Level Inputs) | $\overline{CE}^{*A} \leq 0.2V$ and $\overline{CE}^{*B} \geq V_{DD} - 0.2V^{(5)}$ $SEMR = SEM_L \geq V_{DD} - 0.2V$ $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$ Active Port Outputs Open, $f = f_{MAX}^{(3)}$ | COM'L | S | 85 | 125 | 80 | 115 | 75 | 105 | mA |
| | | | | L | 80 | 105 | 75 | 100 | 70 | 90 | |
| | | | MIL & IND | S | — | — | 80 | 130 | — | — | |
| | | | | L | — | — | 75 | 115 | 70 | 105 | |

5624 tbl 09a

| Symbol | Parameter | Test Condition | Version | 70V25/24X35 Com'1 Only | | 70V25/24X55 Com'1 Only | | Unit | |
|------------------|---|--|-----------|------------------------|------|------------------------|------|------|----|
| | | | | Typ. ⁽²⁾ | Max. | Typ. ⁽²⁾ | Max. | | |
| I _{DD} | Dynamic Operating Current (Both Ports Active) | $\overline{CE} = V_{IL}$, Outputs Open $SEM = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 120 | 180 | 120 | 180 | mA |
| | | | | L | 115 | 155 | 115 | 155 | |
| | | | IND | S | — | — | — | — | |
| | | | | L | — | — | — | — | |
| I _{SB1} | Standby Current (Both Ports - TTL Level Inputs) | \overline{CE}_R and $\overline{CE}_L = V_{IH}$ $SEMR = SEM_L = V_{IH}$ $f = f_{MAX}^{(3)}$ | COM'L | S | 13 | 25 | 13 | 25 | mA |
| | | | | L | 11 | 20 | 11 | 20 | |
| | | | MIL & IND | S | — | — | — | — | |
| | | | | L | — | — | — | — | |
| I _{SB2} | Standby Current (One Port - TTL Level Inputs) | $\overline{CE}^{*A} = V_{IL}$ and $\overline{CE}^{*B} = V_{IH}^{(5)}$ Active Port Outputs Open, $f = f_{MAX}^{(3)}$ $SEMR = SEM_L = V_{IH}$ | COM'L | S | 70 | 100 | 70 | 100 | mA |
| | | | | L | 65 | 90 | 65 | 90 | |
| | | | MIL & IND | S | — | — | — | — | |
| | | | | L | — | — | — | — | |
| I _{SB3} | Full Standby Current (Both Ports - CMOS Level Inputs) | Both Ports \overline{CE}_L and $\overline{CE}_R \geq V_{DD} - 0.2V$, $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(4)}$ $SEMR = SEM_L \geq V_{DD} - 0.2V$ | COM'L | S | 1.0 | 5 | 1.0 | 5 | mA |
| | | | | L | 0.2 | 2.5 | 0.2 | 2.5 | |
| | | | MIL & IND | S | — | — | — | — | |
| | | | | L | — | — | — | — | |
| I _{SB4} | Full Standby Current (One Port - CMOS Level Inputs) | $\overline{CE}^{*A} \leq 0.2V$ and $\overline{CE}^{*B} \geq V_{DD} - 0.2V^{(5)}$ $SEMR = SEM_L \geq V_{DD} - 0.2V$ $V_{IN} \geq V_{DD} - 0.2V$ or $V_{IN} \leq 0.2V$ Active Port Outputs Open, $f = f_{MAX}^{(3)}$ | COM'L | S | 65 | 100 | 65 | 100 | mA |
| | | | | L | 60 | 85 | 60 | 85 | |
| | | | MIL & IND | S | — | — | — | — | |
| | | | | L | — | — | — | — | |

5624 tbl 09b

NOTES:

- 'X' in part number indicates power rating (S or L)
- V_{DD} = 3.3V, T_A = +25°C, and are not production tested. I_{DD} DC = 115mA (typ.)
- At f = f_{MAX}, address and control lines (except Output Enable) are cycling at the maximum frequency read cycle of 1/trc, and using "AC Test Conditions" of input levels of GND to 3V.
- f = 0 means no address or control lines change.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V35/34⁽⁴⁾

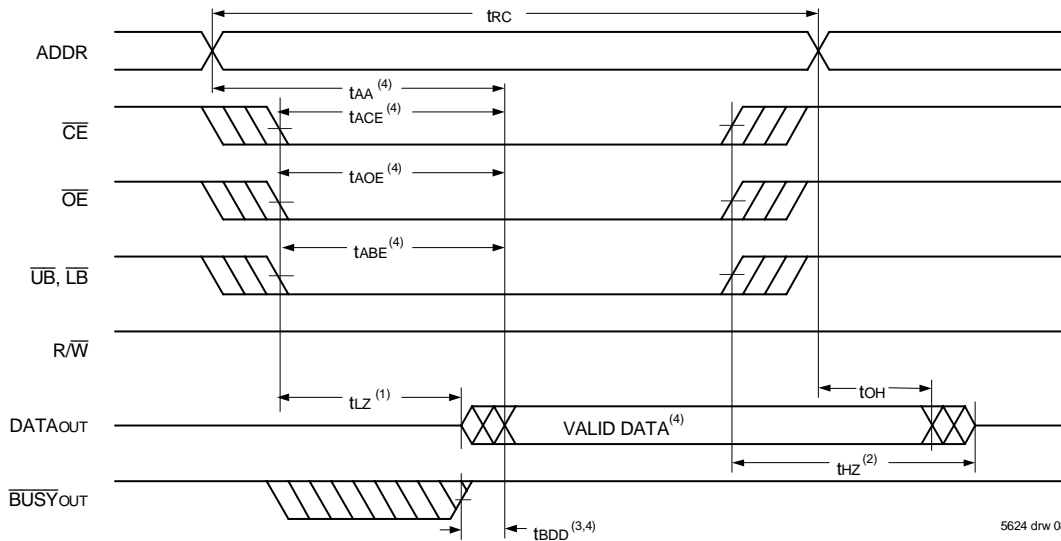
| Symbol | Parameter | 70V35/34X15 Com'l Only | | 70V35/34X20 Com'l & Ind | | 70V35/34X25 Com'l Only | | Unit |
|-------------------|---|---------------------------|------|-------------------------------|------|---------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| READ CYCLE | | | | | | | | |
| t _{RC} | Read Cycle Time | 15 | — | 20 | — | 25 | — | ns |
| t _{AA} | Address Access Time | — | 15 | — | 20 | — | 25 | ns |
| t _{ACE} | Chip Enable Access Time ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |
| t _{ABE} | Byte Enable Access Time ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |
| t _{AOE} | Output Enable Access Time ⁽³⁾ | — | 10 | — | 12 | — | 13 | ns |
| t _{OH} | Output Hold from Address Change | 3 | — | 3 | — | 3 | — | ns |
| t _{LZ} | Output Low-Z Time ^(1,2) | 3 | — | 3 | — | 3 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{PU} | Chip Enable to Power Up Time ^(1,2) | 0 | — | 0 | — | 0 | — | ns |
| t _{PD} | Chip Disable to Power Down Time ^(1,2) | — | 15 | — | 20 | — | 25 | ns |
| t _{SOP} | Semaphore Flag Update Pulse (\overline{OE} or \overline{SEM}) | 10 | — | 10 | — | 10 | — | ns |
| t _{SAA} | Semaphore Address Access ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |

5624 tbl 11

NOTES:

1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. To access RAM, $\overline{CE} = V_{IL}$, \overline{UB} or $\overline{LB} = V_{IL}$, and $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$ or \overline{UB} & $\overline{LB} = V_{IH}$, and $\overline{SEM} = V_{IL}$.
4. 'X' in part number indicates power rating (S or L).

Waveform of Read Cycles⁽⁵⁾



5624 drw 08

NOTES:

1. Timing depends on which signal is asserted last, \overline{OE} , \overline{CE} , \overline{LB} , or \overline{UB} .
2. Timing depends on which signal is de-asserted first, \overline{CE} , \overline{OE} , \overline{LB} , or \overline{UB} .
3. t_{BDD} delay is required only in case where opposite port is completing a write operation to the same address location for simultaneous read operations. \overline{BUSY} has no relation to valid output data.
4. Start of valid data depends on which timing becomes effective last t_{ABE}, t_{AOE}, t_{ACE}, t_{AA} or t_{BDD}.
5. $\overline{SEM} = V_{IH}$.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V25/24⁽⁴⁾

| Symbol | Parameter | 70V25/24X15 Com'l Only | | 70V25/24X20 Com'l & Ind | | 70V25/24X25 Com'l & Ind | | Unit |
|-------------------|---|---------------------------|------|-------------------------------|------|-------------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| READ CYCLE | | | | | | | | |
| t _{RC} | Read Cycle Time | 15 | — | 20 | — | 25 | — | ns |
| t _{AA} | Address Access Time | — | 15 | — | 20 | — | 25 | ns |
| t _{ACE} | Chip Enable Access Time ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |
| t _{ABE} | Byte Enable Access Time ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |
| t _{AOE} | Output Enable Access Time ⁽³⁾ | — | 10 | — | 12 | — | 13 | ns |
| t _{OH} | Output Hold from Address Change | 3 | — | 3 | — | 3 | — | ns |
| t _{LZ} | Output Low-Z Time ^(1,2) | 3 | — | 3 | — | 3 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{PU} | Chip Enable to Power Up Time ^(1,2) | 0 | — | 0 | — | 0 | — | ns |
| t _{PD} | Chip Disable to Power Down Time ^(1,2) | — | 15 | — | 20 | — | 25 | ns |
| t _{SOP} | Semaphore Flag Update Pulse (\overline{OE} or \overline{SEM}) | 10 | — | 10 | — | 10 | — | ns |
| t _{SAA} | Semaphore Address Access ⁽³⁾ | — | 15 | — | 20 | — | 25 | ns |

5624 tbl 11a

| Symbol | Parameter | 70V25/24X35 Com'l Only | | 70V25/24X55 Com'l Only | | Unit |
|-------------------|---|---------------------------|------|---------------------------|------|------|
| | | Min. | Max. | Min. | Max. | |
| READ CYCLE | | | | | | |
| t _{RC} | Read Cycle Time | 35 | — | 55 | — | ns |
| t _{AA} | Address Access Time | — | 35 | — | 55 | ns |
| t _{ACE} | Chip Enable Access Time ⁽³⁾ | — | 35 | — | 55 | ns |
| t _{ABE} | Byte Enable Access Time ⁽³⁾ | — | 35 | — | 55 | ns |
| t _{AOE} | Output Enable Access Time ⁽³⁾ | — | 20 | — | 30 | ns |
| t _{OH} | Output Hold from Address Change | 3 | — | 3 | — | ns |
| t _{LZ} | Output Low-Z Time ^(1,2) | 3 | — | 3 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 15 | — | 25 | ns |
| t _{PU} | Chip Enable to Power Up Time ^(1,2) | 0 | — | 0 | — | ns |
| t _{PD} | Chip Disable to Power Down Time ^(1,2) | — | 35 | — | 50 | ns |
| t _{SOP} | Semaphore Flag Update Pulse (\overline{OE} or \overline{SEM}) | 15 | — | 15 | — | ns |
| t _{SAA} | Semaphore Address Access ⁽³⁾ | — | 35 | — | 55 | ns |

5624 tbl 11b

NOTES:

1. Transition is measured 0mV from Low or High-impedance voltage with Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. To access RAM, $\overline{CE} = V_{IL}$, \overline{UB} or $\overline{LB} = V_{IL}$, and $\overline{SEM} = V_{IH}$. To access semaphore, $\overline{CE} = V_{IH}$ or \overline{UB} & $\overline{LB} = V_{IH}$, and $\overline{SEM} = V_{IL}$.
4. 'X' in part number indicates power rating (S or L).

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage for 70V35/34⁽⁵⁾

| Symbol | Parameter | 70V35/34X15 Com'l Only | | 70V35/34X20 Com'l & Ind | | 70V35/34X25 Com'l Only | | Unit |
|--------------------|--|---------------------------|------|-------------------------------|------|---------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| WRITE CYCLE | | | | | | | | |
| t _{WC} | Write Cycle Time | 15 | — | 20 | — | 25 | — | ns |
| t _{EW} | Chip Enable to End-of-Write ⁽³⁾ | 12 | — | 15 | — | 20 | — | ns |
| t _{AW} | Address Valid to End-of-Write | 12 | — | 15 | — | 20 | — | ns |
| t _{AS} | Address Set-up Time ⁽³⁾ | 0 | — | 0 | — | 0 | — | ns |
| t _{WP} | Write Pulse Width | 12 | — | 15 | — | 20 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | 0 | — | ns |
| t _{DW} | Data Valid to End-of-Write | 10 | — | 15 | — | 15 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{DH} | Data Hold Time ⁽⁴⁾ | 0 | — | 0 | — | 0 | — | ns |
| t _{WZ} | Write Enable to Output in High-Z ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{OW} | Output Active from End-of-Write ^(1,2,4) | 0 | — | 0 | — | 0 | — | ns |
| t _{SWRD} | $\overline{\text{SEM}}$ Flag Write to Read Time | 5 | — | 5 | — | 5 | — | ns |
| t _{SPS} | $\overline{\text{SEM}}$ Flag Contention Window | 5 | — | 5 | — | 5 | — | ns |

5624 tbl 12

NOTES:

1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. To access SRAM, $\overline{\text{CE}} = \text{V}_{\text{IL}}$, $\overline{\text{UB}}$ or $\overline{\text{LB}} = \text{V}_{\text{IL}}$, $\overline{\text{SEM}} = \text{V}_{\text{IH}}$. To access semaphore, $\overline{\text{CE}} = \text{V}_{\text{IH}}$ or $\overline{\text{UB}} \& \overline{\text{LB}} = \text{V}_{\text{IH}}$, and $\overline{\text{SEM}} = \text{V}_{\text{IL}}$. Either condition must be valid for the entire t_{EW} time.
4. The specification for t_{DH} must be met by the device supplying write data to the SRAM under all operating conditions. Although t_{DH} and t_{OW} values will vary over voltage and temperature, the actual t_{DH} will always be smaller than the actual t_{OW}.
5. 'X' in part number indicates power rating (S or L).

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage for 70V25/24⁽⁵⁾

| Symbol | Parameter | 70V25/24X15 Com'l Only | | 70V25/24X20 Com'l & Ind | | 70V25/24X25 Com'l & Ind | | Unit |
|--------------------|--|---------------------------|------|----------------------------|------|----------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| WRITE CYCLE | | | | | | | | |
| t _{WC} | Write Cycle Time | 15 | — | 20 | — | 25 | — | ns |
| t _{EW} | Chip Enable to End-of-Write ⁽³⁾ | 12 | — | 15 | — | 20 | — | ns |
| t _{AW} | Address Valid to End-of-Write | 12 | — | 15 | — | 20 | — | ns |
| t _{AS} | Address Set-up Time ⁽³⁾ | 0 | — | 0 | — | 0 | — | ns |
| t _{WP} | Write Pulse Width | 12 | — | 15 | — | 20 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | 0 | — | ns |
| t _{DW} | Data Valid to End-of-Write | 10 | — | 15 | — | 15 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{DH} | Data Hold Time ⁽⁴⁾ | 0 | — | 0 | — | 0 | — | ns |
| t _{WZ} | Write Enable to Output in High-Z ^(1,2) | — | 10 | — | 12 | — | 15 | ns |
| t _{OW} | Output Active from End-of-Write ^(1,2,4) | 0 | — | 0 | — | 0 | — | ns |
| t _{SWRD} | $\overline{\text{SEM}}$ Flag Write to Read Time | 5 | — | 5 | — | 5 | — | ns |
| t _{SPS} | $\overline{\text{SEM}}$ Flag Contention Window | 5 | — | 5 | — | 5 | — | ns |

5624 tbl 12a

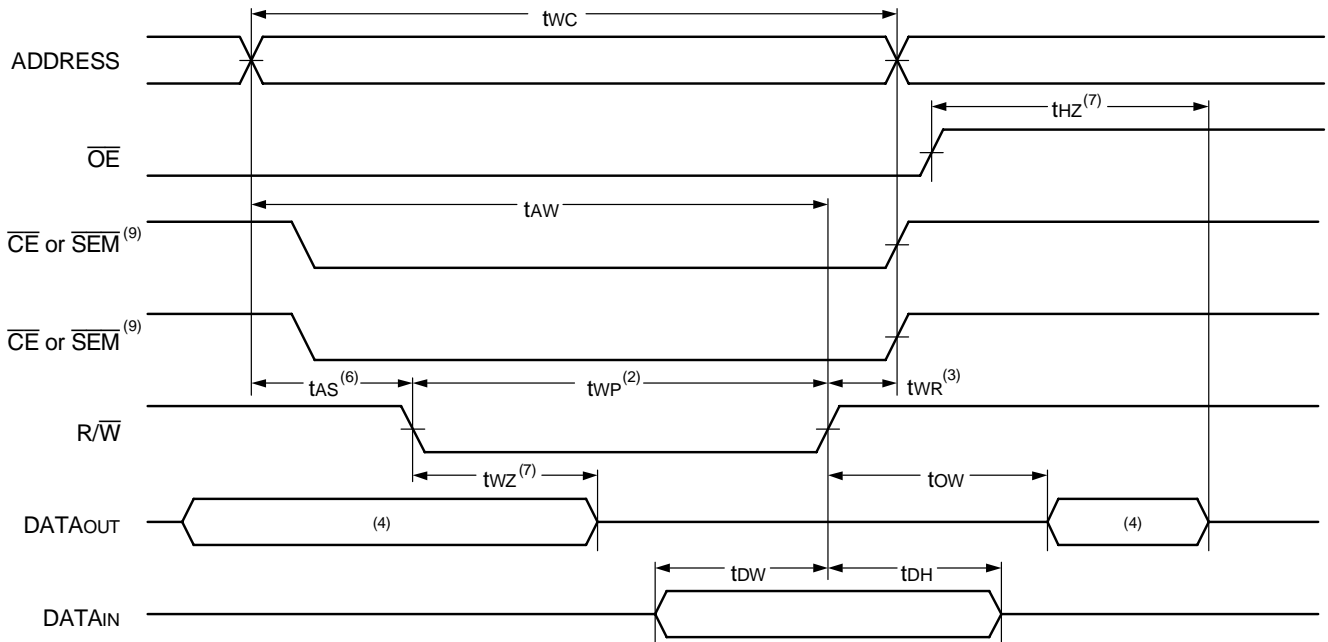
| Symbol | Parameter | 70V25/24X35 Com'l Only | | 70V25/24X55 Com'l Only | | Unit |
|--------------------|--|---------------------------|------|---------------------------|------|------|
| | | Min. | Max. | Min. | Max. | |
| WRITE CYCLE | | | | | | |
| t _{WC} | Write Cycle Time | 35 | — | 55 | — | ns |
| t _{EW} | Chip Enable to End-of-Write ⁽³⁾ | 30 | — | 45 | — | ns |
| t _{AW} | Address Valid to End-of-Write | 30 | — | 45 | — | ns |
| t _{AS} | Address Set-up Time ⁽³⁾ | 0 | — | 0 | — | ns |
| t _{WP} | Write Pulse Width | 25 | — | 40 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | ns |
| t _{DW} | Data Valid to End-of-Write | 15 | — | 30 | — | ns |
| t _{HZ} | Output High-Z Time ^(1,2) | — | 15 | — | 25 | ns |
| t _{DH} | Data Hold Time ⁽⁴⁾ | 0 | — | 0 | — | ns |
| t _{WZ} | Write Enable to Output in High-Z ^(1,2) | — | 15 | — | 25 | ns |
| t _{OW} | Output Active from End-of-Write ^(1,2,4) | 0 | — | 0 | — | ns |
| t _{SWRD} | $\overline{\text{SEM}}$ Flag Write to Read Time | 5 | — | 5 | — | ns |
| t _{SPS} | $\overline{\text{SEM}}$ Flag Contention Window | 5 | — | 5 | — | ns |

5624 tbl 12b

NOTES:

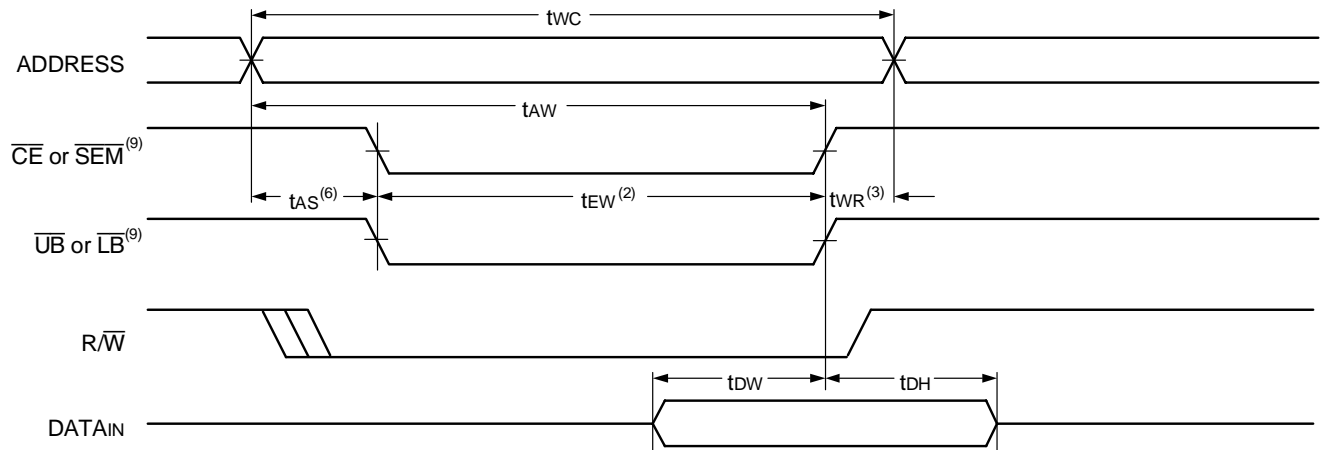
1. Transition is measured 0mV from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. To access SRAM, $\overline{\text{CE}} = \text{V}_{\text{IL}}$, $\overline{\text{UB}}$ or $\overline{\text{LB}} = \text{V}_{\text{IL}}$, $\overline{\text{SEM}} = \text{V}_{\text{IH}}$. To access semaphore, $\overline{\text{CE}} = \text{V}_{\text{IH}}$ or $\overline{\text{UB}} \& \overline{\text{LB}} = \text{V}_{\text{IH}}$, and $\overline{\text{SEM}} = \text{V}_{\text{IL}}$. Either condition must be valid for the entire t_{EW} time.
4. The specification for t_{DH} must be met by the device supplying write data to the SRAM under all operating conditions. Although t_{DH} and t_{OW} values will vary over voltage and temperature, the actual t_{DH} will always be smaller than the actual t_{OW}.
5. 'X' in part number indicates power rating (S or L).

Timing Waveform of Write Cycle No. 1, R/\overline{W} Controlled Timing^(1,5,8)



5624 drw 09

Timing Waveform of Write Cycle No. 2, \overline{CE} , \overline{UB} , \overline{LB} Controlled Timing^(1,5)

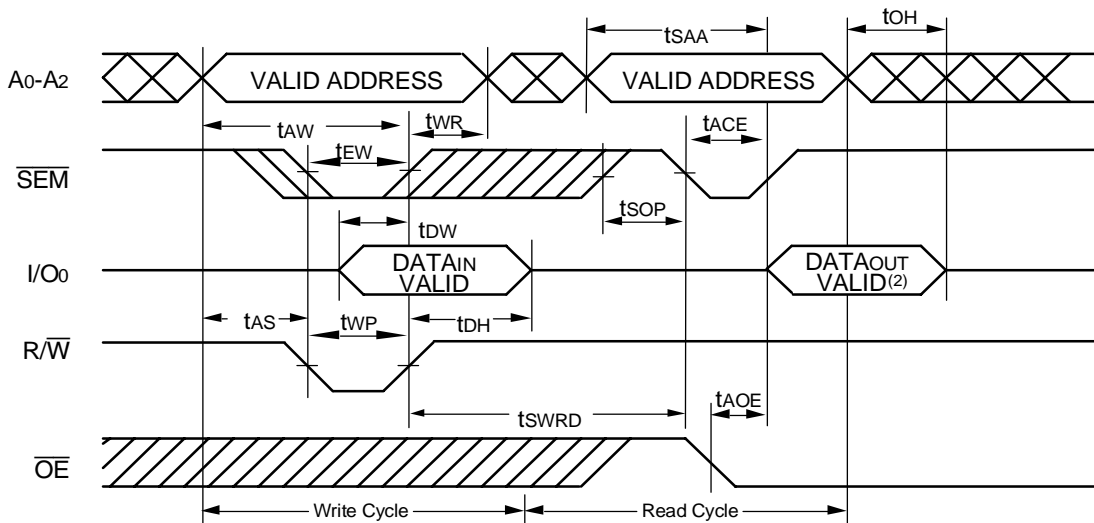


5624 drw 10

NOTES:

1. R/\overline{W} or \overline{CE} or \overline{UB} & \overline{LB} must be HIGH during all address transitions.
2. A write occurs during the overlap (t_{EW} or t_{WP}) of a LOW \overline{UB} or \overline{LB} and a LOW \overline{CE} and a LOW R/\overline{W} for memory array writing cycle.
3. t_{WR} is measured from the earlier of \overline{CE} or R/\overline{W} (or \overline{SEM} or R/\overline{W}) going HIGH to the end-of-write cycle.
4. During this period, the I/O pins are in the output state and input signals must not be applied.
5. If the \overline{CE} or \overline{SEM} LOW transition occurs simultaneously with or after the R/\overline{W} LOW transition the outputs remain in the HIGH-impedance state.
6. Timing depends on which enable signal is asserted last, \overline{CE} , R/\overline{W} , or \overline{UB} or \overline{LB} .
7. This parameter is guaranteed by device characterization, but is not production tested. Transition is measured 0mV from steady state with Output Test Load (Figure 2).
8. If \overline{OE} is LOW during R/\overline{W} controlled write cycle, the write pulse width must be the larger of t_{WP} or $(t_{WZ} + t_{DW})$ to allow the I/O drivers to turn off and data to be placed on the bus for the required t_{OW} . If \overline{OE} is HIGH during an R/\overline{W} controlled write cycle, this requirement does not apply and the write pulse can be as short as the specified t_{WP} .
9. To access SRAM, $\overline{CE} = V_{IL}$, \overline{UB} or $\overline{LB} = V_{IL}$, and $\overline{SEM} = V_{IH}$. To access Semaphore, $\overline{CE} = V_{IH}$ or \overline{UB} and $\overline{LB} = V_{IH}$, and $\overline{SEM} = V_{IL}$. t_{EW} must be met for either condition.

Timing Waveform of Semaphore Read after Write Timing, Either Side⁽¹⁾

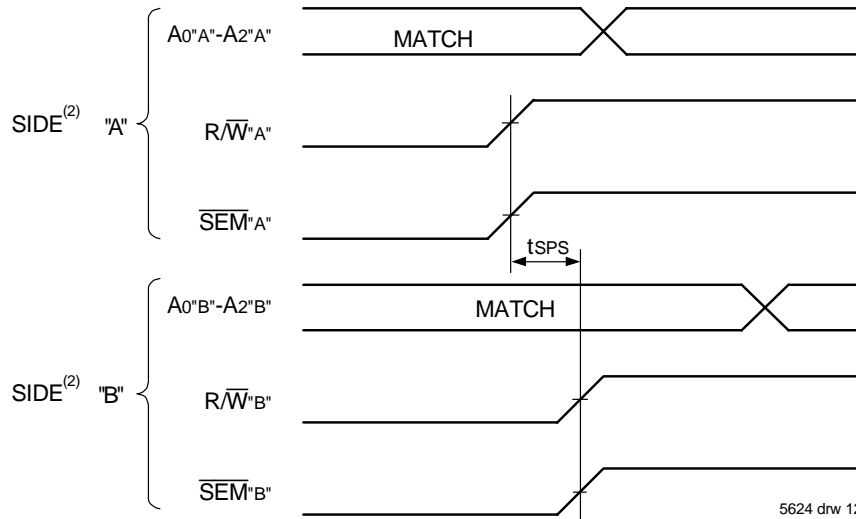


5624 drw 11

NOTES:

1. $\overline{CE} = V_{IH}$ or $\overline{UB} \& \overline{LB} = V_{IH}$ for the duration of the above timing (both write and read cycle).
2. "DATAout VALID" represents all I/O's (I/O₀-I/O₁₇ for IDT70V35/34) and (I/O₀-I/O₁₅ for IDT70V25/24) equal to the semaphore value.

Timing Waveform of Semaphore Write Contention^(1,3,4)



5624 drw 12

NOTES:

1. $DOR = DOL = V_{IL}$, $\overline{CE}_R = \overline{CE}_L = V_{IH}$, or both $\overline{UB} \& \overline{LB} = V_{IH}$.
2. All timing is the same for left and right port. Port "A" may be either left or right port. Port "B" is the opposite from port "A".
3. This parameter is measured from R/\overline{W}^A or \overline{SEM}^A going HIGH to R/\overline{W}^B or \overline{SEM}^B going HIGH.
4. If tSPS is not satisfied, there is no guarantee which side will obtain the semaphore flag.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V35/34⁽⁶⁾

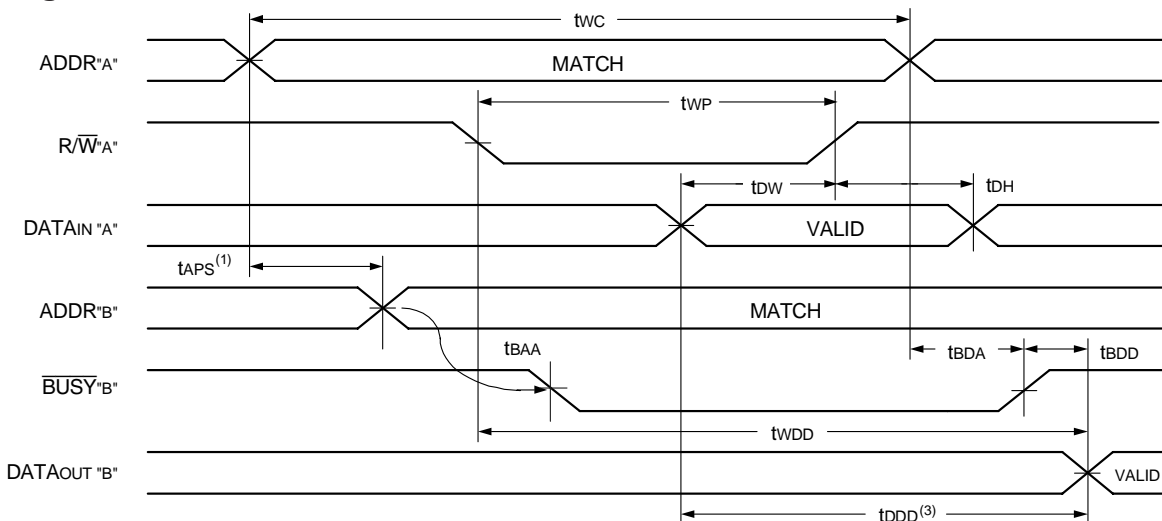
| Symbol | Parameter | 70V35/34X15 Com'l Only | | 70V35/34X20 Com'l & Ind | | 70V35/34X25 Com'l Only | | Unit |
|--|---|------------------------|------|-------------------------|------|------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| BUSY TIMING ($M/\bar{S} = V_{IH}$) | | | | | | | | |
| tBAA | \overline{BUSY} Access Time from Address Match | — | 15 | — | 20 | — | 20 | ns |
| tBDA | \overline{BUSY} Disable Time from Address Not Matched | — | 15 | — | 20 | — | 20 | ns |
| tBAC | \overline{BUSY} Access Time from Chip Enable LOW | — | 15 | — | 20 | — | 20 | ns |
| tBDC | \overline{BUSY} Disable Time from Chip Enable HIGH | — | 15 | — | 17 | — | 17 | ns |
| tAPS | Arbitration Priority Set-up Time ⁽²⁾ | 5 | — | 5 | — | 5 | — | ns |
| tBDD | \overline{BUSY} Disable to Valid Data ⁽³⁾ | — | 18 | — | 30 | — | 30 | ns |
| tWH | Write Hold After \overline{BUSY} ⁽⁵⁾ | 12 | — | 15 | — | 17 | — | ns |
| BUSY TIMING ($M/\bar{S} = V_{IL}$) | | | | | | | | |
| tWB | \overline{BUSY} Input to Write ⁽⁴⁾ | 0 | — | 0 | — | 0 | — | ns |
| tWH | Write Hold After \overline{BUSY} ⁽⁵⁾ | 12 | — | 15 | — | 17 | — | ns |
| PORT-TO-PORT DELAY TIMING | | | | | | | | |
| tWDD | Write Pulse to Data Delay ⁽¹⁾ | — | 30 | — | 45 | — | 50 | ns |
| tDDD | Write Data Valid to Read Data Delay ⁽¹⁾ | — | 25 | — | 35 | — | 35 | ns |

5624 tbl 13

NOTES:

- Port-to-port delay through SRAM cells from writing port to reading port, refer to "TIMING WAVEFORM OF WRITE PORT-TO-PORT READ AND \overline{BUSY} ($M/\bar{S} = V_{IH}$)".
- To ensure that the earlier of the two ports wins.
- tBDD is a calculated parameter and is the greater of 0, tWDD - tWP (actual) or tDDD - tDW (actual).
- To ensure that the write cycle is inhibited during contention.
- To ensure that a write cycle is completed after contention.
- 'X' in part number indicates power rating (S or L).

Timing Waveform of Write Port-to-Port Read and \overline{BUSY} ^(2,4,5) ($M/\bar{S} = V_{IH}$)



NOTES:

- To ensure that the earlier of the two ports wins. tAPS is ignored for $M/\bar{S} = V_{IL}$ (slave).
- $\overline{CE}_L = \overline{CE}_R = V_{IL}$.
- $\overline{OE} = V_{IL}$ for the reading port.
- If $M/\bar{S} = V_{IL}$ (slave), \overline{BUSY} is an input. Then for this example \overline{BUSY} *A = V_{IH} and \overline{BUSY} *B input is shown above.
- All timing is the same for both left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from port "A".

5624 drw 13

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V25/24⁽⁶⁾

| Symbol | Parameter | 70V25/24X15 Com'l Ony | | 70V25/24X20 Com'l & Ind | | 70V25/24X25 Com'l & Ind | | Unit |
|---|--|-----------------------|------|-------------------------|------|-------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| $\overline{\text{BUSY}}$ TIMING ($M/\overline{\text{S}} = V_{IH}$) | | | | | | | | |
| t _{BAA} | $\overline{\text{BUSY}}$ Access Time from Address Match | — | 15 | — | 20 | — | 20 | ns |
| t _{BDA} | $\overline{\text{BUSY}}$ Disable Time from Address Not Matched | — | 15 | — | 20 | — | 20 | ns |
| t _{BAC} | $\overline{\text{BUSY}}$ Access Time from Chip Enable LOW | — | 15 | — | 20 | — | 20 | ns |
| t _{BDC} | $\overline{\text{BUSY}}$ Disable Time from Chip Enable HIGH | — | 15 | — | 17 | — | 17 | ns |
| t _{APS} | Arbitration Priority Set-up Time ⁽²⁾ | 5 | — | 5 | — | 5 | — | ns |
| t _{BDD} | $\overline{\text{BUSY}}$ Disable to Valid Data ⁽³⁾ | — | 18 | — | 30 | — | 30 | ns |
| t _{WH} | Write Hold After $\overline{\text{BUSY}}$ ⁽⁵⁾ | 12 | — | 15 | — | 17 | — | ns |
| $\overline{\text{BUSY}}$ TIMING ($M/\overline{\text{S}} = V_{IL}$) | | | | | | | | |
| t _{WB} | $\overline{\text{BUSY}}$ Input to Write ⁽⁴⁾ | 0 | — | 0 | — | 0 | — | ns |
| t _{WH} | Write Hold After $\overline{\text{BUSY}}$ ⁽⁵⁾ | 12 | — | 15 | — | 17 | — | ns |
| PORT-TO-PORT DELAY TIMING | | | | | | | | |
| t _{WDD} | Write Pulse to Data Delay ⁽¹⁾ | — | 30 | — | 45 | — | 50 | ns |
| t _{DDD} | Write Data Valid to Read Data Delay ⁽¹⁾ | — | 25 | — | 35 | — | 35 | ns |

5624 tbl 13a

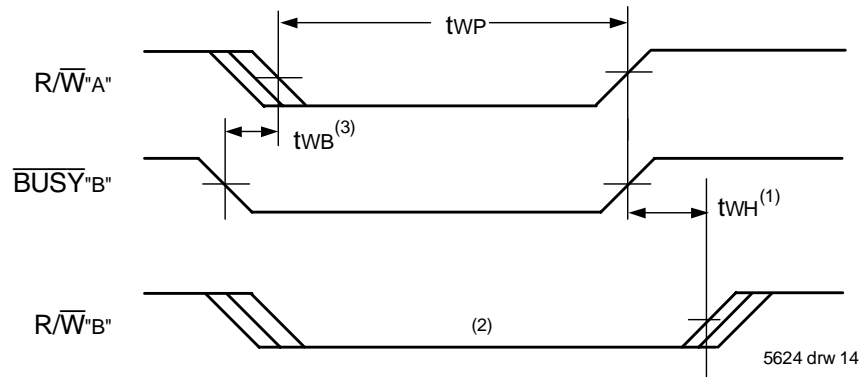
| Symbol | Parameter | 70V25/24X35 Com'l Only | | 70V25/24X55 Com'l Only | | Unit |
|---|--|------------------------|------|------------------------|------|------|
| | | Min. | Max. | Min. | Max. | |
| $\overline{\text{BUSY}}$ TIMING ($M/\overline{\text{S}} = V_{IH}$) | | | | | | |
| t _{BAA} | $\overline{\text{BUSY}}$ Access Time from Address Match | — | 20 | — | 45 | ns |
| t _{BDA} | $\overline{\text{BUSY}}$ Disable Time from Address Not Matched | — | 20 | — | 40 | ns |
| t _{BAC} | $\overline{\text{BUSY}}$ Access Time from Chip Enable LOW | — | 20 | — | 40 | ns |
| t _{BDC} | $\overline{\text{BUSY}}$ Disable Time from Chip Enable HIGH | — | 20 | — | 35 | ns |
| t _{APS} | Arbitration Priority Set-up Time ⁽²⁾ | 5 | — | 5 | — | ns |
| t _{BDD} | $\overline{\text{BUSY}}$ Disable to Valid Data ⁽³⁾ | — | 35 | — | 40 | ns |
| t _{WH} | Write Hold After $\overline{\text{BUSY}}$ ⁽⁵⁾ | 25 | — | 25 | — | ns |
| $\overline{\text{BUSY}}$ TIMING ($M/\overline{\text{S}} = V_{IL}$) | | | | | | |
| t _{WB} | $\overline{\text{BUSY}}$ Input to Write ⁽⁴⁾ | 0 | — | 0 | — | ns |
| t _{WH} | Write Hold After $\overline{\text{BUSY}}$ ⁽⁵⁾ | 25 | — | 25 | — | ns |
| PORT-TO-PORT DELAY TIMING | | | | | | |
| t _{WDD} | Write Pulse to Data Delay ⁽¹⁾ | — | 60 | — | 80 | ns |
| t _{DDD} | Write Data Valid to Read Data Delay ⁽¹⁾ | — | 45 | — | 65 | ns |

5624 tbl 13b

NOTES:

1. Port-to-port delay through SRAM cells from writing port to reading port, refer to "TIMING WAVEFORM OF WRITE PORT-TO-PORT READ AND $\overline{\text{BUSY}}$ ($M/\overline{\text{S}} = V_{IH}$)".
2. To ensure that the earlier of the two ports wins.
3. t_{BDD} is a calculated parameter and is the greater of 0, t_{WDD} - t_{WP} (actual) or t_{DDD} - t_{WR} (actual).
4. To ensure that the write cycle is inhibited during contention.
5. To ensure that a write cycle is completed after contention.
6. 'X' in part number indicates power rating (S or L).

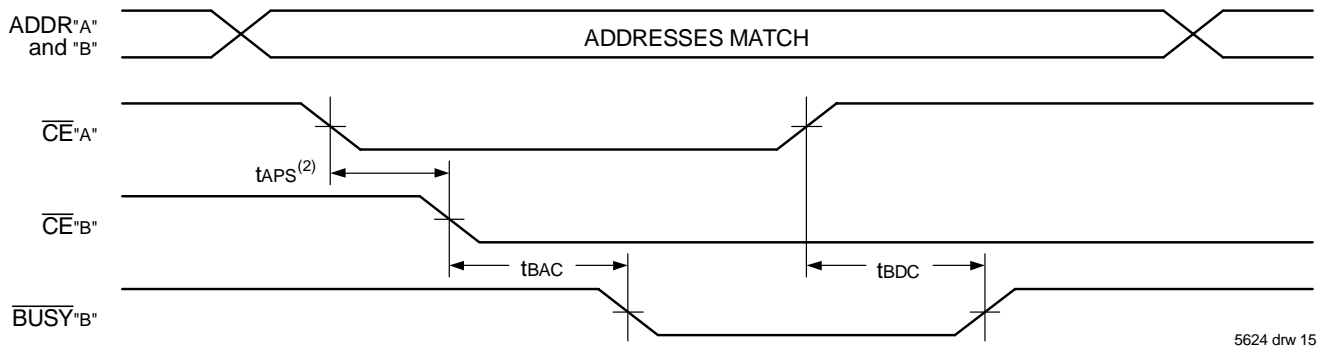
Timing Waveform of Write with **BUSY**



NOTES:

1. t_{WH} must be met for both master \overline{BUSY} input (slave) and output (master).
2. \overline{BUSY} is asserted on port "B" blocking R/\overline{W} 'B', until \overline{BUSY} 'B' goes HIGH.
3. t_{WB} is only for the slave version.

Waveform of **BUSY** Arbitration Controlled by \overline{CE} Timing⁽¹⁾ ($M/\overline{S} = V_{IH}$)



Waveform of **BUSY** Arbitration Cycle Controlled by Address Match Timing⁽¹⁾ ($M/\overline{S} = V_{IH}$)



NOTES:

1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from "A".
2. If t_{APS} is not satisfied, the \overline{BUSY} signal will be asserted on one side or another but there is no guarantee on which side \overline{BUSY} will be asserted.

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V35/34⁽¹⁾

| Symbol | Parameter | 70V35/34X15 Com'l Only | | 70V35/34X20 Com'l & Ind | | 70V35/34X25 Com'l Only | | Unit |
|-------------------------|----------------------|------------------------|------|-------------------------|------|------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| INTERRUPT TIMING | | | | | | | | |
| t _{AS} | Address Set-up Time | 0 | — | 0 | — | 0 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | 0 | — | ns |
| t _{INS} | Interrupt Set Time | — | 15 | — | 20 | — | 20 | ns |
| t _{INR} | Interrupt Reset Time | — | 15 | — | 20 | — | 20 | ns |

5624 tbl 14

AC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range for 70V25/24⁽¹⁾

| Symbol | Parameter | 70V25/24X15 Com'l Only | | 70V25/24X20 Com'l & Ind | | 70V25/24X25 Com'l & Ind | | Unit |
|-------------------------|----------------------|------------------------|------|-------------------------|------|-------------------------|------|------|
| | | Min. | Max. | Min. | Max. | Min. | Max. | |
| INTERRUPT TIMING | | | | | | | | |
| t _{AS} | Address Set-up Time | 0 | — | 0 | — | 0 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | 0 | — | ns |
| t _{INS} | Interrupt Set Time | — | 15 | — | 20 | — | 20 | ns |
| t _{INR} | Interrupt Reset Time | — | 15 | — | 20 | — | 20 | ns |

5624 tbl 14a

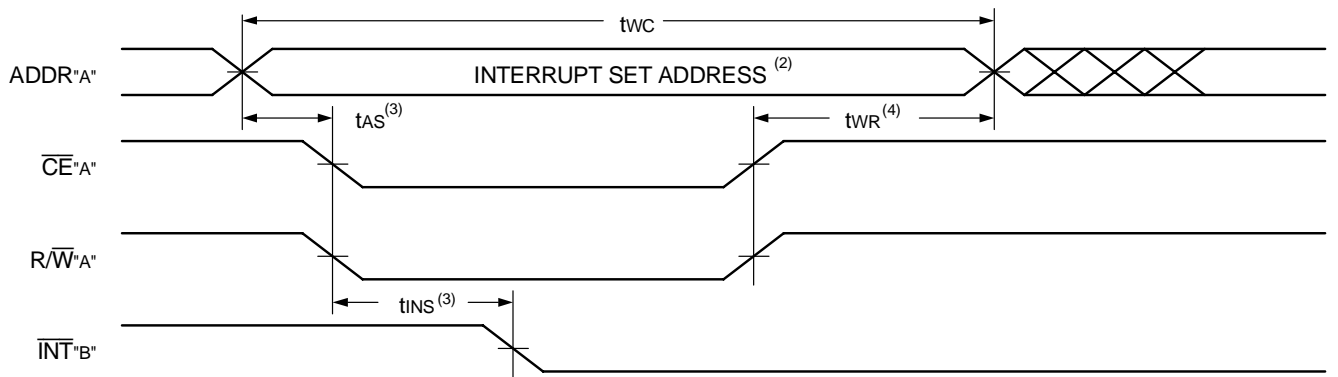
| Symbol | Parameter | 70V25/24X35 Com'l Only | | 70V25/24X55 Com'l Only | | Unit |
|-------------------------|----------------------|------------------------|------|------------------------|------|------|
| | | Min. | Max. | Min. | Max. | |
| INTERRUPT TIMING | | | | | | |
| t _{AS} | Address Set-up Time | 0 | — | 0 | — | ns |
| t _{WR} | Write Recovery Time | 0 | — | 0 | — | ns |
| t _{INS} | Interrupt Set Time | — | 25 | — | 40 | ns |
| t _{INR} | Interrupt Reset Time | — | 25 | — | 40 | ns |

5624 tbl 14b

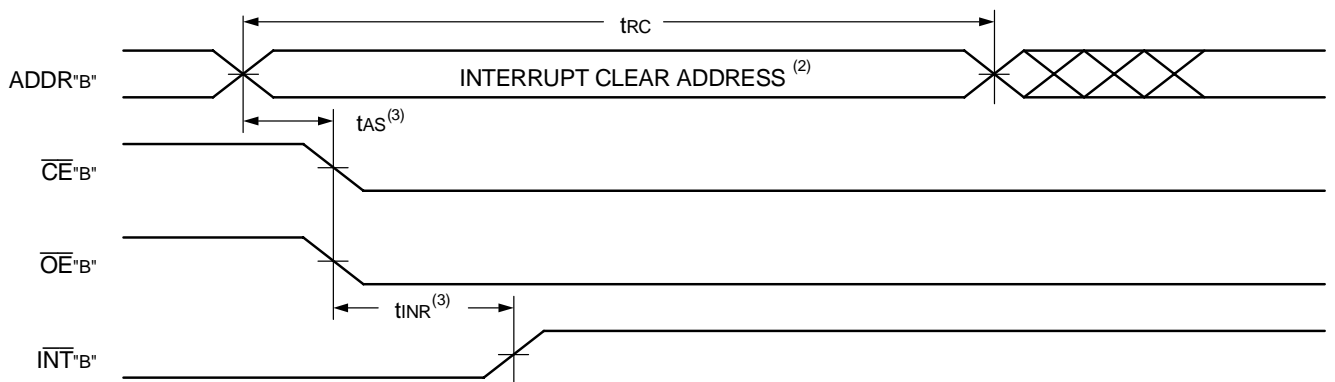
NOTES:

- 'X' in part number indicates power rating (S or L).

Waveform of Interrupt Timing⁽¹⁾



5624 drw 17



5624 drw 18

NOTES:

1. All timing is the same for left and right ports. Port "A" may be either the left or right port. Port "B" is the port opposite from "A".
2. See Interrupt Flag Truth Table III.
3. Timing depends on which enable signal (\overline{CE} or R/\overline{W}) is asserted last.
4. Timing depends on which enable signal (\overline{CE} or R/\overline{W}) is de-asserted first.

Truth Table III — Interrupt Flag⁽¹⁾

| Left Port | | | | | Right Port | | | | | Function |
|------------------|-----------------------------|-----------------------------|--|------------------|------------------|-----------------------------|-----------------------------|--|------------------|-----------------------------------|
| R/W _L | C _E _L | O _E _L | A _{12L} -A _{0L} ⁽⁴⁾ | INT _L | R/W _R | C _E _R | O _E _R | A _{12R} -A _{0R} ⁽⁴⁾ | INT _R | |
| L | L | X | 1FFF ⁽⁴⁾ | X | X | X | X | X | L ⁽²⁾ | Set Right INT _R Flag |
| X | X | X | X | X | X | L | L | 1FFF ⁽⁴⁾ | H ⁽³⁾ | Reset Right INT _R Flag |
| X | X | X | X | L ⁽³⁾ | L | L | X | 1FFE ⁽⁴⁾ | X | Set Left INT _L Flag |
| X | L | L | 1FFE ⁽⁴⁾ | H ⁽²⁾ | X | X | X | X | X | Reset Left INT _L Flag |

NOTES:

- Assumes $\overline{\text{BUSY}}_L = \overline{\text{BUSY}}_R = V_{IH}$.
- If $\overline{\text{BUSY}}_L = V_{IL}$, then no change.
- If $\overline{\text{BUSY}}_R = V_{IL}$, then no change.
- A₁₂ is a NC for IDT70V34 and for IDT70V24, therefore Interrupt Addresses are FFF and FFE.

5624 tbl 15

Truth Table IV — Address **BUSY** Arbitration

| Inputs | | | Outputs | | Function |
|-----------------------------|-----------------------------|---|---|---|------------------------------|
| C _E _L | C _E _R | A _{12L} -A _{0L} ⁽⁴⁾ A _{12R} -A _{0R} | $\overline{\text{BUSY}}_L$ ⁽¹⁾ | $\overline{\text{BUSY}}_R$ ⁽¹⁾ | |
| X | X | NO MATCH | H | H | Normal |
| H | X | MATCH | H | H | Normal |
| X | H | MATCH | H | H | Normal |
| L | L | MATCH | Note ⁽²⁾ | Note ⁽²⁾ | Write Inhibit ⁽³⁾ |

5624 tbl 16

NOTES:

- Pins $\overline{\text{BUSY}}_L$ and $\overline{\text{BUSY}}_R$ are both outputs when the part is configured as a master. Both are inputs when configured as a slave. $\overline{\text{BUSY}}$ outputs on the IDT70V35/34 (IDT70V25/24) are push pull, not open drain outputs. On slaves the $\overline{\text{BUSY}}$ input internally inhibits writes.
- L if the inputs to the opposite port were stable prior to the address and enable inputs of this port. V_{IH} if the inputs to the opposite port became stable after the address and enable inputs of this port. If t_{APS} is not met, either $\overline{\text{BUSY}}_L$ or $\overline{\text{BUSY}}_R = \text{LOW}$ will result. $\overline{\text{BUSY}}_L$ and $\overline{\text{BUSY}}_R$ outputs cannot be LOW simultaneously.
- Writes to the left port are internally ignored when $\overline{\text{BUSY}}_L$ outputs are driving LOW regardless of actual logic level on the pin. Writes to the right port are internally ignored when $\overline{\text{BUSY}}_R$ outputs are driving LOW regardless of actual logic level on the pin.
- A₁₂ is a NC for IDT70V34 and for IDT70V24. Address comparison will be for A₀ - A₁₁.

Truth Table V — Example of Semaphore Procurement Sequence^(1,2,3)

| Functions | D ₀ - D ₁₇ Left ⁽²⁾ | D ₀ - D ₁₇ Right ⁽²⁾ | Status |
|------------------------------------|--|---|--|
| No Action | 1 | 1 | Semaphore free |
| Left Port Writes "0" to Semaphore | 0 | 1 | Left port has semaphore token |
| Right Port Writes "0" to Semaphore | 0 | 1 | No change. Right side has no write access to semaphore |
| Left Port Writes "1" to Semaphore | 1 | 0 | Right port obtains semaphore token |
| Left Port Writes "0" to Semaphore | 1 | 0 | No change. Left port has no write access to semaphore |
| Right Port Writes "1" to Semaphore | 0 | 1 | Left port obtains semaphore token |
| Left Port Writes "1" to Semaphore | 1 | 1 | Semaphore free |
| Right Port Writes "0" to Semaphore | 1 | 0 | Right port has semaphore token |
| Right Port Writes "1" to Semaphore | 1 | 1 | Semaphore free |
| Left Port Writes "0" to Semaphore | 0 | 1 | Left port has semaphore token |
| Left Port Writes "1" to Semaphore | 1 | 1 | Semaphore free |

NOTES:

- This table denotes a sequence of events for only one of the eight semaphores on the IDT70V35/34 (IDT70V25/24).
- There are eight semaphore flags written to via I/O₀ and read from all I/O's (I/O₀-I/O₁₇ for IDT70V35/34) and (I/O₀-I/O₁₅ for IDT70V25/24). These eight semaphores are addressed by A₀-A₂.
- C_E = V_{IH}, $\overline{\text{SEM}} = V_{IL}$ to access the semaphores. Refer to the Semaphore Read/Write Control Truth Tables.

5624 tbl 17

software. As an example, the semaphore can be used by one processor to inhibit the other from accessing a portion of the Dual-Port SRAM or any other shared resource.

The Dual-Port SRAM features a fast access time, and both ports are completely independent of each other. This means that the activity on the left port in no way slows the access time of the right port. Both ports are identical in function to standard CMOS Static RAM and can be accessed at the same time with the only possible conflict arising from the simultaneous writing of, or a simultaneous READ/WRITE of, a non-semaphore location. Semaphores are protected against such ambiguous situations and may be used by the system program to avoid any conflicts in the non-semaphore portion of the Dual-Port SRAM. These devices have an automatic power-down feature controlled by \overline{CE} , the Dual-Port SRAM enable, and SEM, the semaphore enable. The \overline{CE} and SEM pins control on-chip power down circuitry that permits the respective port to go into standby mode when not selected. This is the condition which is shown in Truth Table I where \overline{CE} and SEM are both HIGH.

Systems which can best use the IDT70V35/34 (IDT70V25/24) contain multiple processors or controllers and are typically very high-speed systems which are software controlled or software intensive. These systems can benefit from a performance increase offered by the IDT70V35/34 (IDT70V25/24)'s hardware semaphores, which provide a lockout mechanism without requiring complex programming.

Software handshaking between processors offers the maximum in system flexibility by permitting shared resources to be allocated in varying configurations. The IDT70V35/34 (IDT70V25/24) does not use its semaphore flags to control any resources through hardware, thus allowing the system designer total flexibility in system architecture.

An advantage of using semaphores rather than the more common methods of hardware arbitration is that wait states are never incurred in either processor. This can prove to be a major advantage in very high-speed systems.

How the Semaphore Flags Work

The semaphore logic is a set of eight latches which are independent of the Dual-Port SRAM. These latches can be used to pass a flag, or token, from one port to the other to indicate that a shared resource is in use. The semaphores provide a hardware assist for a use assignment method called "Token Passing Allocation." In this method, the state of a semaphore latch is used as a token indicating that shared resource is in use. If the left processor wants to use this resource, it requests the token by setting the latch. This processor then verifies its success in setting the latch by reading it. If it was successful, it proceeds to assume control over the shared resource. If it was not successful in setting the latch, it determines that the right side processor has set the latch first, has the token and is using the shared resource. The left processor can then either repeatedly request that semaphore's status or remove its request for that semaphore to perform another task and occasionally attempt again to gain control of the token via the set and test sequence. Once the right side has relinquished the token, the left side should succeed in gaining control.

The semaphore flags are active LOW. A token is requested by writing a zero into a semaphore latch and is released when the same side writes a one to that latch.

The eight semaphore flags reside within the IDT70V35/34 (IDT70V25/24) in a separate memory space from the Dual-Port SRAM. This address space is accessed by placing a LOW input on the SEM pin (which acts as

a chip select for the semaphore flags) and using the other control pins (Address, \overline{OE} , and $R\overline{W}$) as they would be used in accessing a standard static RAM. Each of the flags has a unique address which can be accessed by either side through address pins A0 – A2. When accessing the semaphores, none of the other address pins has any effect.

When writing to a semaphore, only data pin D0 is used. If a LOW level is written into an unused semaphore location, that flag will be set to a zero on that side and a one on the other side (see Truth Table V). That semaphore can now only be modified by the side showing the zero. When a one is written into the same location from the same side, the flag will be set to a one for both sides (unless a semaphore request from the other side is pending) and then can be written to by both sides. The fact that the side which is able to write a zero into a semaphore subsequently locks out writes from the other side is what makes semaphore flags useful in interprocessor communications. (A thorough discussion on the use of this feature follows shortly.) A zero written into the same location from the other side will be stored in the semaphore request latch for that side until the semaphore is freed by the first side.

When a semaphore flag is read, its value is spread into all data bits so that a flag that is a one reads as a one in all data bits and a flag containing a zero reads as all zeros. The read value is latched into one side's output register when that side's semaphore select (\overline{SEM}) and output enable (\overline{OE}) signals go active. This serves to disallow the semaphore from changing state in the middle of a read cycle due to a write cycle from the other side. Because of this latch, a repeated read of a semaphore in a test loop must cause either signal (\overline{SEM} or \overline{OE}) to go inactive or the output will never change.

A sequence WRITE/READ must be used by the semaphore in order to guarantee that no system level contention will occur. A processor requests access to shared resources by attempting to write a zero into a semaphore location. If the semaphore is already in use, the semaphore request latch will contain a zero, yet the semaphore flag will appear as one, a fact which the processor will verify by the subsequent read (see Truth Table V). As an example, assume a processor writes a zero to the left port at a free semaphore location. On a subsequent read, the processor will verify that it has written successfully to that location and will assume control over the resource in question. Meanwhile, if a processor on the right side attempts to write a zero to the same semaphore flag it will fail, as will be verified by the fact that a one will be read from that semaphore on the right side during subsequent read. Had a sequence of READ/WRITE been used instead, system contention problems could have occurred during the gap between the read and write cycles.

It is important to note that a failed semaphore request must be followed by either repeated reads or by writing a one into the same location. The reason for this is easily understood by looking at the simple logic diagram of the semaphore flag in Figure 4. Two semaphore request latches feed into a semaphore flag. Whichever latch is first to present a zero to the semaphore flag will force its side of the semaphore flag LOW and the other side HIGH. This condition will continue until a one is written to the same semaphore request latch. Should the other side's semaphore request latch have been written to a zero in the meantime, the semaphore flag will flip over to the other side as soon as a one is written into the first side's request latch. The second side's flag will now stay LOW until its semaphore request latch is written to a one. From this it is easy to understand that, if a semaphore is requested and the processor which requested it no longer needs the resource, the entire system can hang up until a one is written into that

Ordering Information

| XXXXX | A | A | 999 | A | A | A | |
|-------------|------|-------|-------|---------|----------------------------|--|------------------------|
| Device Type | Step | Power | Speed | Package | Process/ Temperature Range | | |
| | | | | | Blank I ⁽¹⁾ | Commercial (0°C to +70°C) Industrial (-40°C to +85°C) | |
| | | | | | G ⁽²⁾ | Green | |
| | | | | | PF | 100-pin TQFP (PN100-1) | 70V35/34/25/24 |
| | | | | | G | 84-Pin PGA (G84-3) | 70V25/24 |
| | | | | | J | 84-Pin PLCC (J84-1) | 70V25/24 |
| | | | | | 15 | Commercial Only - 70V35/34/25/24 | } Speed in Nanoseconds |
| | | | | | 20 | Commercial & Industrial - 70V35/34/25/24 | |
| | | | | | 25 | Commercial Only - 70V35/34 | |
| | | | | | 25 | Commercial & Industrial - 70V25/24 | |
| | | | | | 35 | Commercial Only - 70V25/24 | |
| | | | | | 55 | Commercial Only - 70V25/24 | |
| | | | | | S | Standard Power | |
| | | | | | L | Low Power | |
| | | | | | Blank | No stepping designation | |
| | | | | | T | Current Stepping | |
| | | | | | 70V35 | 144K (8K x 18-Bit) 3.3V Dual-Port RAM | |
| | | | | | 70V34 | 72K (4K x 18-Bit) 3.3V Dual-Port RAM | |
| | | | | | 70V25 | 128K (8K x 16-Bit) 3.3V Dual-Port RAM | |
| | | | | | 70V24 | 64K (4K x 16-Bit) 3.3V Dual-Port RAM | |

5624 drw 21a

NOTES:

- Contact your local sales office for Industrial temp range for other speeds, packages and powers.
- Green parts available. For specific speeds, packages and powers contact your local sales office.

Datasheet Document History

| | |
|-----------|---|
| 06/08/00: | Initial Public Offering |
| 08/09/01: | Page 1 Corrected I/O numbering Page 5-7, 10 & 12 Removed Industrial temperature range offering for 25ns from DC & AC Electrical Characteristics Page 17 Removed Industrial temperature range offering for 25ns speed from the ordering information Added Industrial temperature offering footnote |
| 07/02/02: | Page 2 Added date revision for pin configuration Added 70V34 to datasheet (4K x 18) |
| 06/22/04: | Consolidated 70V25/24 datasheets (8/4K x 16) into 70V35/34 (8/4K x 18) datasheet Removed Preliminary status from datasheet Page 2 & 3 Changed naming convention from V _{CC} to V _{DD} and from GND to V _{SS} for PN100 packages Page 7 Updated Conditions in Capacitance table Page 7 Added Junction Temperature to Absolute Maximum Ratings table Page 9, 11, 13, 17 &, 19 Added DC and AC Electrical Characteristics tables for 70V25/24 data Page 21 & 22 Changed Interrupt flag table, footnotes and Interrupts text to reflect 70V25/24 data Page 1 & 15 Replaced old ® logo with new ™ logo |
| 10/28/04: | Page 25 Added stepping indicator to ordering information |
| 04/05/05: | Page 1 Added green availability to features Page 25 Added green indicator to ordering information |
| 10/23/08: | Page 25 Removed "IDT" from orderable part number |



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